

New Application: Kuo-Len LIN et al.
Filed: November 5, 2003
Title: Dual-Layer Heat Dissipating Structure
Docket No.: PO-92325
Correspondence: Yi-Wen Tseng
TEL/FAX: 703-534-3562

1a

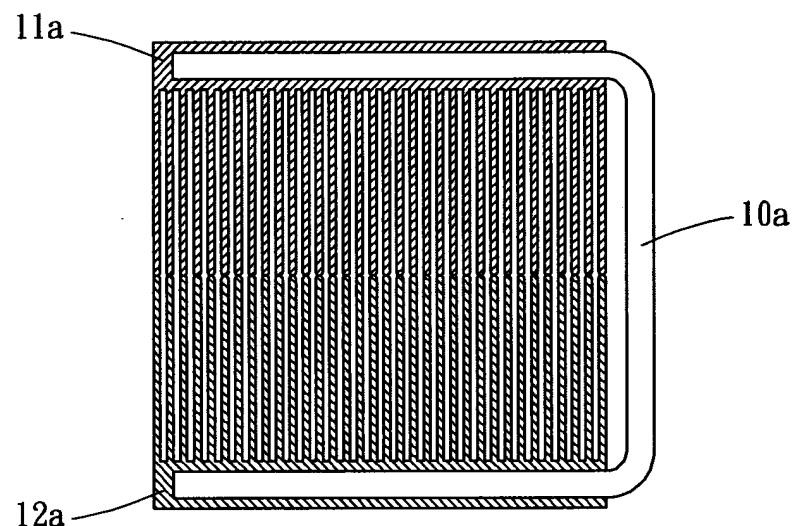


FIG. 1
PRIOR ART

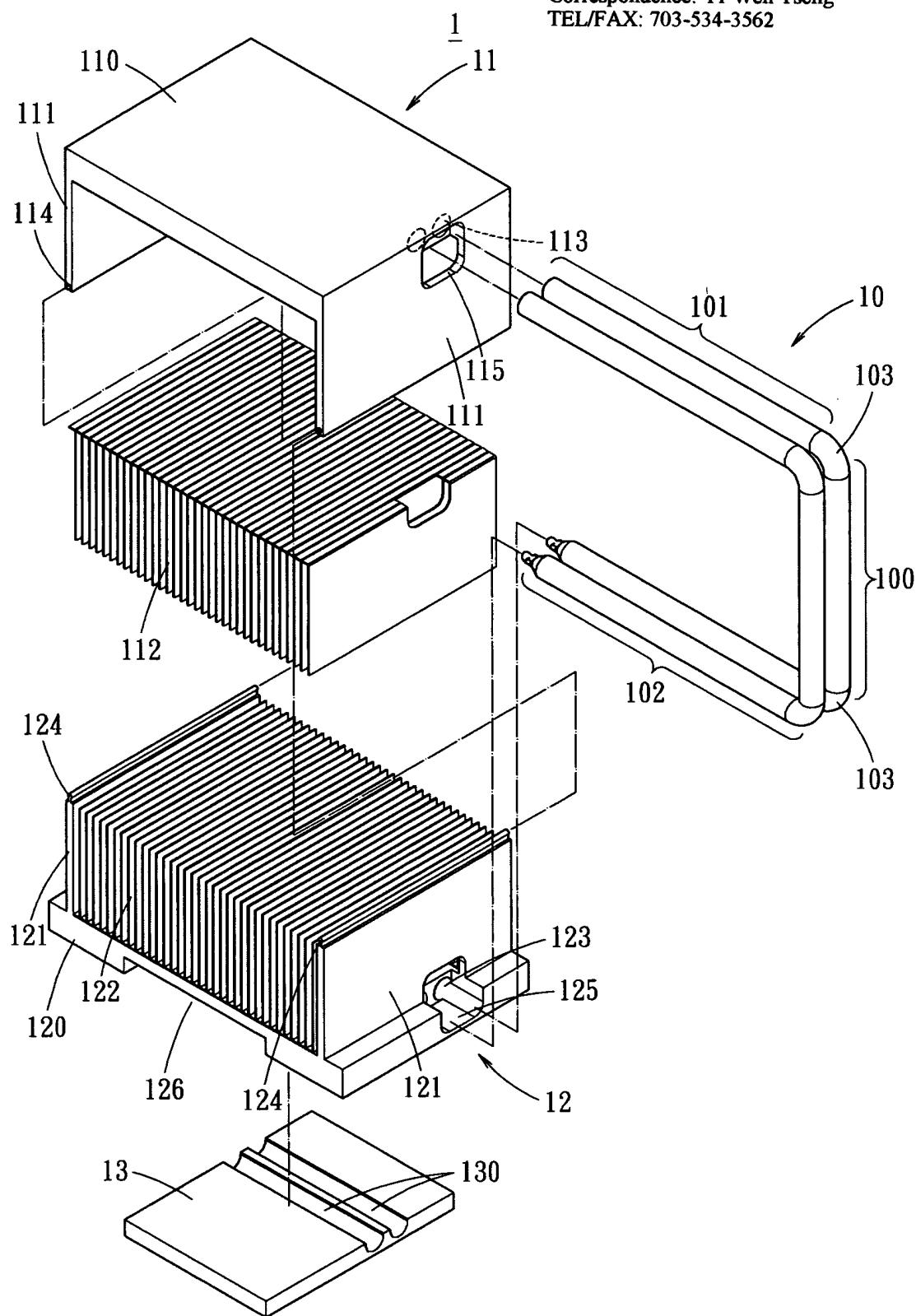


FIG. 2

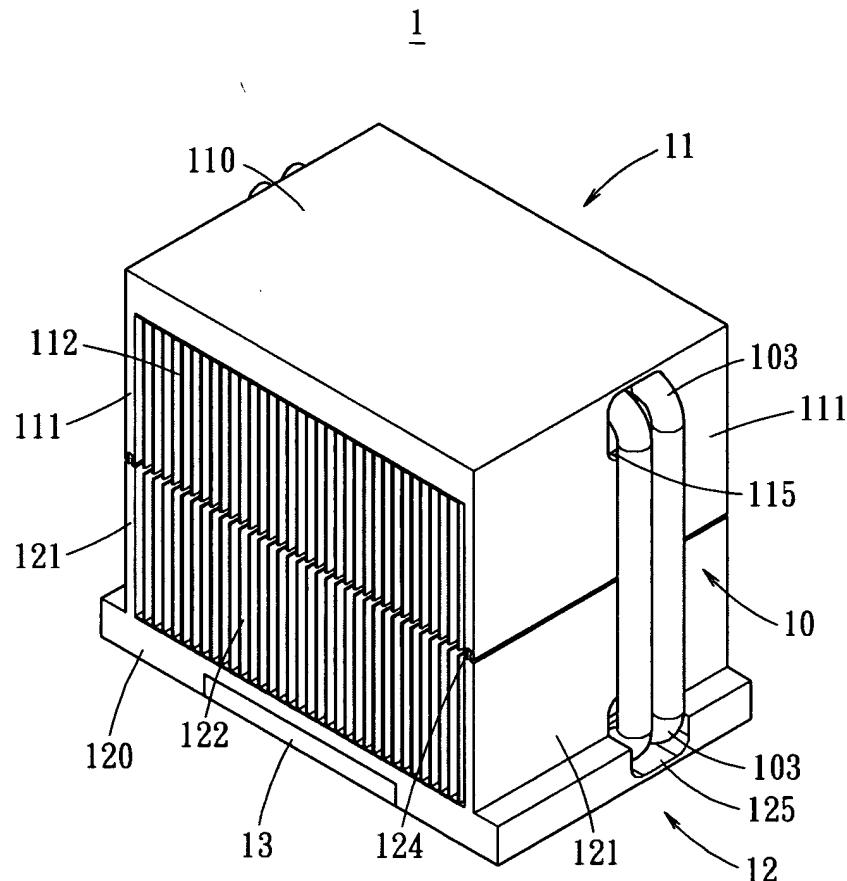


FIG. 3

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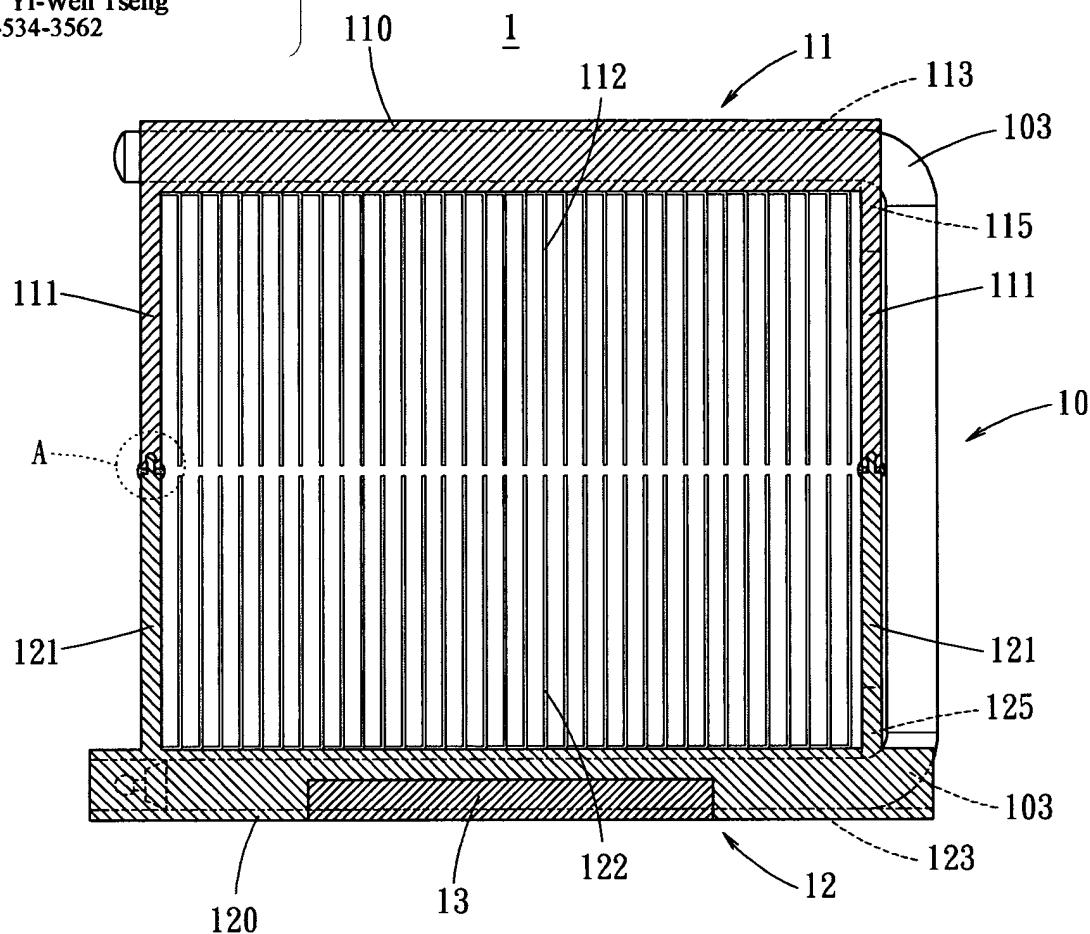


FIG. 4

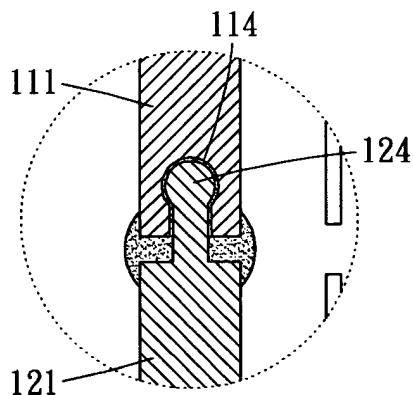
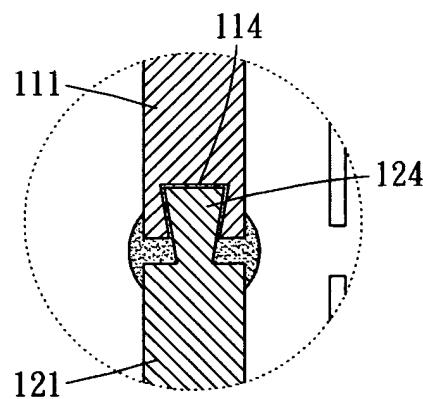
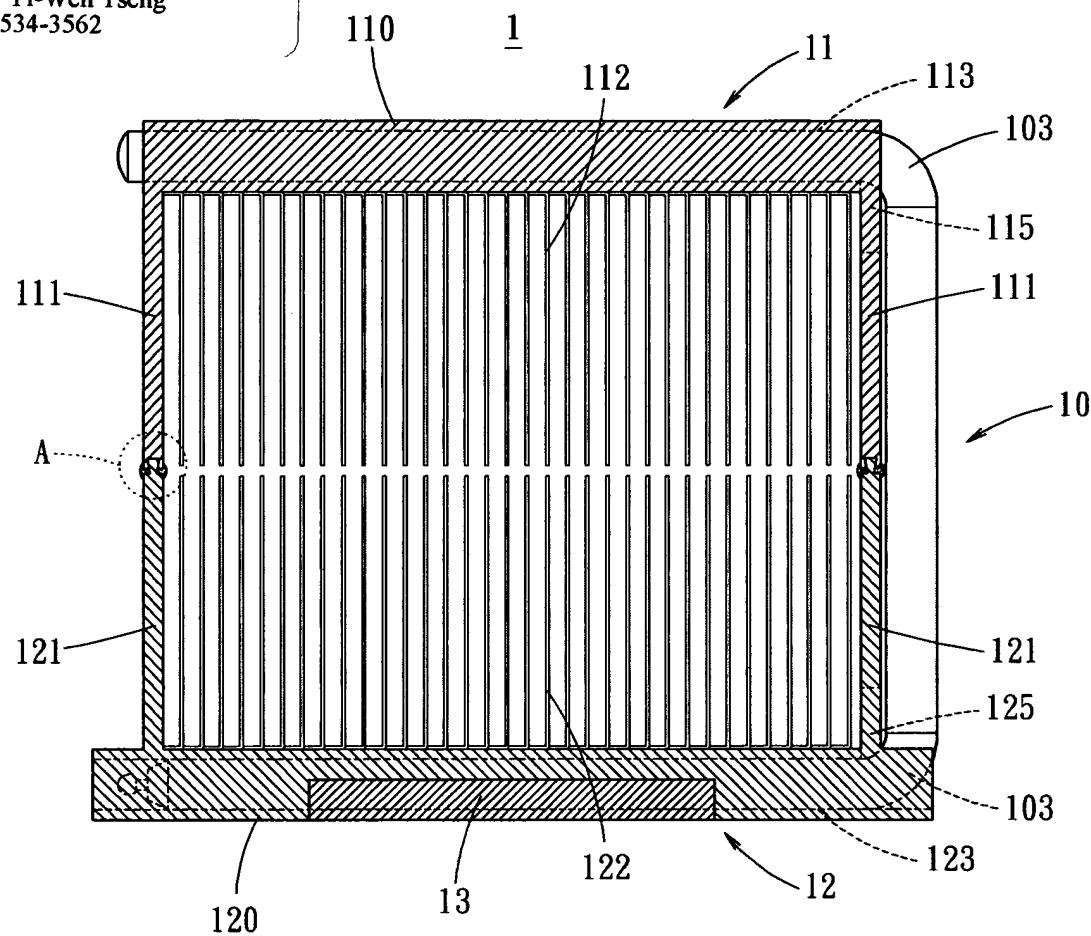


FIG. 5



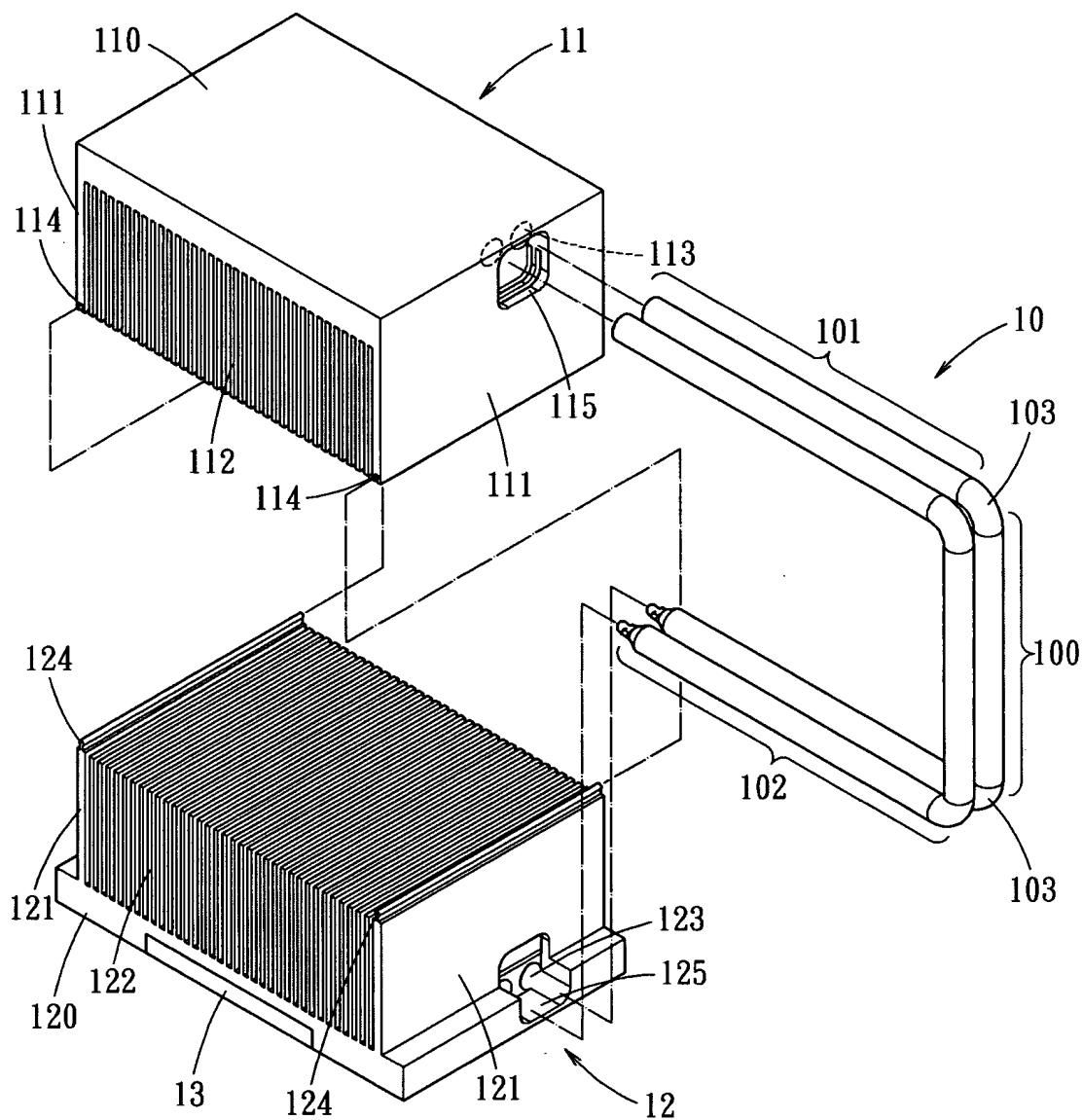


FIG. 8

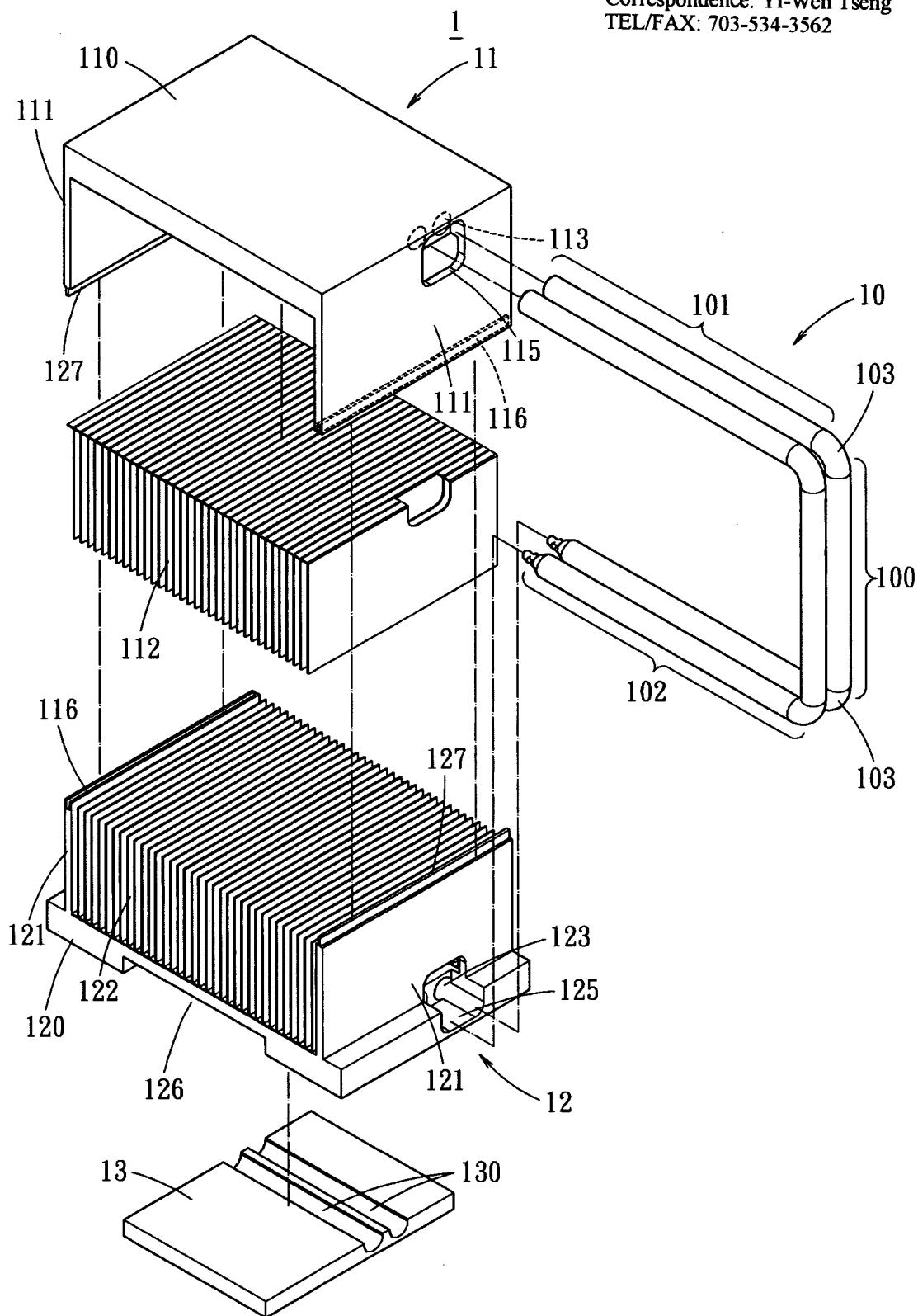


FIG. 9

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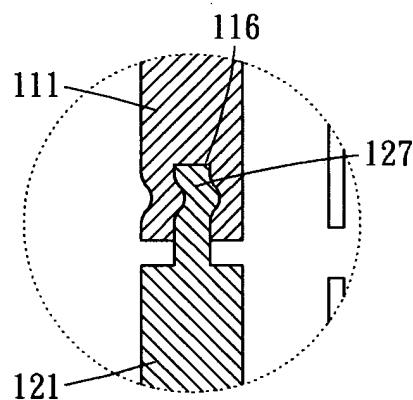


FIG. 10